



#### **Development of LArTPC for Neutrino Physics**





### Outline

- LArTPCs for Neutrino Physics
- Principle of LArTPC
  - LArTPC Signal Processing
  - Wire-Cell Tomographic Event Reconstruction
  - Optimization of LArTPCs
- Summary



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#### **Big Questions in Neutrino Physics?**

- Are neutrinos responsible for the large matter anti-matter asymmetry?
- What's the neutrino mass hierarchy?
- Are neutrino Dirac or Majorana particles? №
- What is the neutrino mass?
- Are there sterile neutrinos?



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#### Deep Underground Neutrino Experiment (DUNE)



DUNE is designed to search for new CP violation, determine the mass hierarchy, test the unitarity of PMNS matrix through precision measurement of (anti)v<sub>µ</sub>→(anti)v<sub>e</sub>





Δ

#### Short-Baseline Neutrino Program

 Search for light sterile neutrino through search for anomalous v<sub>µ</sub>→v<sub>e</sub> oscillation motivated by LSND and MiniBooNE anomalies





arXiv:1503.01520v1

#### Principle of Single-Phase Liquid Argon Time Projection Chamber (LArTPC)

- LArTPC has mm scale position resolution with multiple 1D wire readouts
- Energy deposition and topology can be used to do PID
- Ar: the most abundant noble gas (





Anode wire planes:

Drift velocity 1.6 km/s  $\rightarrow$  several ms drift time

#### Unique $e/\gamma$ separation in LArTPC



• Gap Identification + dE/dx for LArTPC





# Early History of the Development of LArTPC

- W. Willis and V. Radeka, Liquid argon ionization chambers as total absorption detector, NIMA 120:221 (1974)
- D. R. Nygren, The Time Projection Chamber: A New 4π Detector for Charged Particles. eConf. C740805:58 (1974)
- H. H. Chen et al. A Neutrino detector sensitive to rare process. I. A study of neutrino electron reactions. FNAL-Proposal-0496 (1976)
- C. Rubbia, The liquid argon time projection chamber: a new concept for neutrino detector, CERN-EP/77-08 (1977)





V. Radeka

William Willis



H. H. Chen



D. R. Nygren



C. Rubbia

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#### History of the Development of LArTPC



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## Charge Particle going through LAr

Ionization signal is very small



 Ultra pure LAr (~ ppb O<sub>2</sub> and ppt H<sub>2</sub>O) is needed as O(10<sup>12</sup>) collisions every second for an electron

### Single-Phase TPC Signal Formation



• Induction plane signal strongly depends on the local charge distribution, collection plane signal is much simpler

#### Challenges in LArTPC Signal

- Wire/strip readout is essential!
  - Power consumption of pixel readout in LAr is 1-2 orders higher than what we can handle
  - 40 kton detector  $\rightarrow$  cost of pixel readout
    - MicroBooNE (60 tons) 8256 wires vs. 3 million pixel readout
  - Important to have induction wire planes in addition to the collection wire plane
- There is no electron amplification inside LAr
  - Signal is very small ~10s k electrons
  - Cold electronics is essential to minimize electronics noise considering large wire capacitance



### **Enabling Technology: Cold Electronics**



- Placing the preamplifier inside LAr significantly reduced the electronics noise
  - 5-6 times comparing to past warm electronics (10:1 → 60:1 MIP peak-to-noise ratio in the collection)
  - Significantly improve the performance of induction wire plane

#### Cold Electronics Performance in MicroBooNE



Wire Noise Level in MicroBooNE

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## TPC Signal Processing → Recover Ionization Electrons

 $\mathbf{M}(t_0) = \left| R(t - t_0) \cdot S(t) \cdot dt \right|$ Fourier transformation  $M(\omega) = \mathbf{R}(\omega) \cdot \mathbf{S}(\omega)$ Frequency domain  $M(\omega)$  $|S(\omega)|$  $\cdot F(\omega)$ Anti-Fourier Back to time transformation domain **S(t)** 

 Signal processing is based on deconvolution technique

- O(N<sup>3</sup>) matrix inversion is achieved through a O(N logN) fast Fourier transformation
- General good for collection plane signals
- Not good for induction plane signals due to lack of universal average response function

#### 2-D Deconvolution

$$M_{i}(t_{0}) = \int_{t} \left( R_{0}(t-t_{0}) \cdot S_{i}(t) + R_{1}(t-t_{0}) \cdot S_{i+1}(t) + \dots \right) dt$$
$$M_{i}(\omega) = R_{0}(\omega) \cdot S_{i}(\omega) + R_{1}(\omega) \cdot S_{i+1}(\omega) + \dots$$

$$\begin{pmatrix} M_{1}(\omega) \\ M_{2}(\omega) \\ \dots \\ M_{n-1}(\omega) \\ M_{n}(\omega) \end{pmatrix} = \begin{pmatrix} R_{0}(\omega) & R_{1}(\omega) & \dots & R_{n-2}(\omega) & R_{n-1}(\omega) \\ R_{1}(\omega) & R_{0}(\omega) & \dots & R_{n-3}(\omega) & \dots & R_{n-3}(\omega) & R_{n-2}(\omega) \\ \dots & \dots & \dots & \dots & \dots \\ R_{n-2}(\omega) & R_{n-3}(\omega) & \dots & R_{0}(\omega) & R_{1}(\omega) \\ R_{n-1}(\omega) & R_{n-2}(\omega) & \dots & R_{1}(\omega) & R_{0}(\omega) \end{pmatrix} \cdot \begin{pmatrix} S_{1}(\omega) \\ S_{2}(\omega) \\ \dots \\ S_{n-1}(\omega) \\ S_{n}(\omega) \end{pmatrix}$$

- With induced signals, the signal is still linear sum of direct signal and induced signal
  - R<sub>1</sub> represents the induced signal from i+1th wire signal to ith wire
  - S<sub>i</sub> and S<sub>i+1</sub> are not directly related

#### The inversion of matrix R can again be done with deconvolution through 2-D FFT

#### Just 2D deconvolution will not be enough $\rightarrow$ ROI + Adaptive Baseline

 The bi-polar nature of induction signal amplify the lowfrequency noise during deconvolution

$$\mathbf{S}(\omega) = \frac{\mathbf{M}(\omega)}{\mathbf{R}(\omega)} \cdot F(\omega)$$

Signal mV/fC

1000

800

600

400

200

0ª

-40

-20

Frequency Content

40

Frequency (a.b. unit)

20

20

Time (us)

U induction

V induction

W collection

60

80

40



- One can improve the situation through ROI and baseline correction
  - Given N time bins with 2 MHz digitization frequency, the lowest freq (above 0) is 2/N MHz
  - Obviously not sensitive to noise < 2/N MHz
  - 200 bins  $\rightarrow$  10 kHz



#### Induction U plane

#### **Collection plane**



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### Challenges of Event Reconstruction in LArTPCs

- Event topology:
  - Tracks, showers, unknown vertex in LArTPCs
  - Simple tracks in collider's gas TPCs





- Wire vs. Pixel readout
  - Large LArTPCs has to use wire readout due to **power consumption** of electronics and **costs**
  - Puedo-3D detector

#### 2D matching $\rightarrow$ 3D

## Cathode Plane Edistin ~ 500V/cm



#### **Wire-Cell Approach**



Fig.1:Basic principle of tomography: superposition free tomographic cross sections S1 and S2 compared with the projected image P

https://en.wikipedia.org/wiki/Tomography

#### Wire-Cell Imaging



#### Solving for Images

 $\chi^{2} = (\mathbf{B} \cdot \mathbf{W} - G \cdot C)^{T} V_{BW}^{-1} (\mathbf{B} \cdot \mathbf{W} - G \cdot C)$  $\frac{\partial \chi^{2}}{\partial C} = 0 \rightarrow C = (\mathbf{G}^{T} V_{BW}^{-1} \mathbf{G})^{-1} G^{T} V_{BW}^{-1} BW$ 

- C: charge in each (merged) cell
- G: Geometry matrix connecting cells and wires
- W: charge in each single wire
- B: Geometry matrix connecting merged wires and single wires
- V<sub>BW</sub>: Covariance matrix describing uncertainty in wire charge



- Use two-plane as an example
- Red points are true hits
- Blue ones are fake hits



#### Same formulism for Wrapped Wire

$$\chi^{2} = (\mathbf{B} \cdot \mathbf{W} - \mathbf{G} \cdot \mathbf{C})^{T} V_{BW}^{-1} (\mathbf{B} \cdot \mathbf{W} - \mathbf{G} \cdot \mathbf{C})$$
$$\mathbf{C} = (\mathbf{G}^{T} V_{BW}^{-1} \mathbf{G})^{-1} \mathbf{G}^{T} V_{BW}^{-1} \mathbf{B} W$$

- C: charge in each (merged) cell
- G: Geometry matrix connecting cells and **channels**
- W: charge in each single **channel**
- B: Geometry matrix connecting merged channels and single channels
- V<sub>BW</sub>: Covariance matrix describing uncertainty in **channel** charge







More 3D events can be found at http://www.phy.bnl.gov/wire-cell/bee/ Bee: interactive 3D display

#### **Connectivity information**

- Use the connectivity information to choose the optimal imaging solution
  - Penalty term added in  $\chi^2$



#### Without Connectivity



#### With Connectivity

#### **Strategy Comparison**

#### **2D Matching**

- Start with 2D (time+wire x 3)
- 2D pattern recognition
  - Particle track/cluster information
- Matching 2D patterns into 3D objects
  - Time information (start/end of clusters)
  - Geometry information
  - Some charge information to remove ambiguities in matching

Each approach uses the same set information in different order!

#### **3D Tomography**

- Start with 2D (wire+wire+wire at fixed time slice)
- 2D image reconstruction
  - Explicit Time + Geometry + Charge information
  - Some connectivity information can be used
- 3D image reconstruction
  - Straight forward
- 3D pattern recognition
  - Particle track/cluster information (tracks, showers)

## Wire-Cell Pattern Recognition (under developing)

 Given the 3D images, pattern recognition is performed with the track and shower hypotheses



- Operations are all "local" i.e. Hough transformation, Crawler, Vertex fitting/merging ...
- Too many different topologies → many corner cases

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#### Information from LArTPC



- Time information: when ionization electrons arrive (drift distance)
- Geometry information: which wires are fired (transverse position)
- Charge information: how many ionization electrons (energy deposition)

#### Limited Geometry information for Wire Readout





• Due to the wire readout, the geometry information is not as robust as the time information





#### **Default: Parallel TPC Orientation**





Parallel APA w.r.t beam

- Perpendicular APA  $\rightarrow$  fewer hit wires + more times info  $\rightarrow$  less ambiguities
- Parallel APA  $\rightarrow$  easier situation for induction plane signal processing

#### Parallel vs. Perpendicular APA

|                            | Longitudinal<br>(Drift) | Transverse |
|----------------------------|-------------------------|------------|
| Digitization<br>length     | 0.8 mm                  | 3-5 mm     |
| Diffusion (σ)              | <1.7 mm                 | <2.4 mm    |
| Electronics<br>Shaping (σ) | 1.3 mm                  | N/A        |
| Field Response<br>Function | ~1.1 mm                 | 3-5 mm     |

- Better resolution in the drift direction
- Perpendicular APA expects a better e/gamma separation with better gap identification and dE/dx resolution
- Induction signal processing is the key!



### Parallel vs. Perpendicular TPC

|                                  | CC-QE       | CC-Res           | CC-DIS       | Total        | Vertex-overlapping | Displaced-overlapping |  |
|----------------------------------|-------------|------------------|--------------|--------------|--------------------|-----------------------|--|
|                                  |             |                  |              | Signal       | Bkgd.              | Bkgd.                 |  |
| Events                           | 175.2       | 254.1            | 371.8        | 801.1        |                    |                       |  |
| Parallel TPC                     |             |                  |              |              |                    |                       |  |
| $\theta_h, \theta_e < 2.5^\circ$ | 2.5~(1.4%)  | 4.4 (1.7%)       | 6.3~(1.6%)   | 13.2~(1.6%)  | 15.5 (1.9%)        | 21.6 (2.7%)           |  |
| $\theta_h, \theta_e < 5.0^\circ$ | 7.0(3.9%)   | $16.2 \ (6.3\%)$ | 22.5~(5.6%)  | 45.6(5.4%)   | 52.9~(6.6%)        | 95.1 (11.9%)          |  |
| $\theta_h, \theta_e < 7.5^\circ$ | 12.1~(6.8%) | 32.5 (12.6%)     | 45.7 (11.3%) | 90.3~(10.8%) | 103.5 (12.9%)      | 189.4 (23.6%)         |  |
| Perpendicular TPC                |             |                  |              |              |                    |                       |  |
| $\theta_h, \theta_e < 2.5^\circ$ | 0.0~(0.0%)  | 0.1~(0.0%)       | 0.2~(0.1%)   | 0.3~(0.0%)   | 1.6 (0.2%)         | 1.6~(0.2%)            |  |
| $\theta_h, \theta_e < 5.0^\circ$ | 0.0~(0.0%)  | 0.2~(0.1%)       | 0.9~(0.2%)   | 1.1~(0.1%)   | 5.8(0.7%)          | 6.0 (0.7%)            |  |
| $\theta_h, \theta_e < 7.5^\circ$ | 0.1~(0.0%)  | 0.5~(0.2%)       | 1.8~(0.5%)   | 2.4~(0.3%)   | 12.1~(1.5%)        | $13.9\ (1.7\%)$       |  |

 Significant background reduction is expected for perpendicular TPC → increased physics sensitivity

#### Four Wire Planes: Reduction of Ambiguities



- Ambiguities can be evaluated by comparing the "# of real hits" and the "# of potential hits"
- Take two-plane as an example
  - 3 real hits
  - 6 potential hits (each has two fired wires going through them)
- Ambiguities can be reduced with Connectivity, Charge, Recognized Pattern information
  - These tools are powerful, but not yet robust enough
  - It is much desired to have less ambiguities to start with

#### Four Wire Planes: Reduction of Ambiguities



- Three-plane setting is much better than two-plane setting, the latter has two much ambiguities
- Four-plane setting can significantly reduce the ambiguities, especially when things are busy

#### **Robustness Against Dead Channels**

**Overall** 

efficiency

- In reality, it is highly unlikely to have 100% good ٠ channels for a 10 kt detector
- Let's assume "p" is the efficiency of a single plane, the given "n" number of planes, the  $\mathcal{E}_n = p^n$ volume efficiency can be estimated as

1x1 m<sup>2</sup> 3 mm pitch

3 planes



$$\mathcal{E}_{n-1} = p^n + n \cdot (1-p) \cdot p^{n-1}$$

However, the cost of higher efficiency is an increase of ambiguities (i.e. fake hits)

$$\left( \frac{F_n}{P_n} + (1-p) \cdot n \cdot \left( F_{n-1} - F_n \right) \right) \cdot \mathcal{E}_{n-1}$$

**Original fake hits** at "n" planes

Increase of fake hits due to dead channel, leaked from fake hits at "n-1" planes, n different "n-1" planes



5% dead wires for dotted lines 40

## **ROI finder in TPC Induction Signal Processing**

- The developed ROI finder is very complicated, and uses the connectivity information and also cut off at ~ O(100) us
- Some part of the phase space will be lost ...
  - http://www.phy.bnl.gov/wire-cell/bee/set/pps/event/0/?theme=light



- Each band is for one induction wire plane
- Adding one more plane (4 wire planes) will largely reduce these regions (other benefits not covered here)
- ROI finder would rely on the other three planes' tight ROI

#### Summary

- Significant progresses have been made in the TPC signal processing and event reconstruction
  - 2D deconvolution + Wire-Cell Tomographic Reconstruction
  - Challenges still remains in achieving low electronic noises and high-quality automated event reconstruction
- Lots of room available to improve the LArTPC design and performance for DUNE's four 10 kt modules
  - Perpendicular TPC orientation, four wire planes ...
- LArTPC technology may hold the key to many major discoveries:
  - Lepontic CP violation, neutrino mass ordering, proton decay, sterile neutrinos ...
- Exciting program in the next decades

#### **Before and After Excess Noise Filter**



MicroBooNE preliminary

Excess noises are observed and have to be filtered



#### **Induction U-Plane Channel**

This harmonic noise filtered out directly in the frequency domain (noise in the drift high voltage)

Coherent noise subtraction for the regulator noise (power supply to the preamp)

> MicroBooNE preliminary

#### **Excess Noise Removed via Hardware Fix**



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